N and P Channel Enhancement Mode Power MOSFET

Description

The G1NP02LLE uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

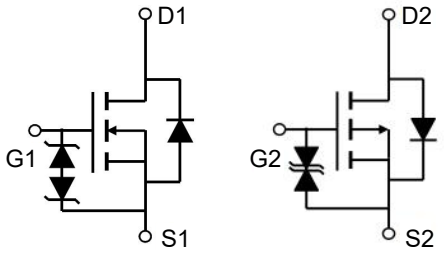
General Features

- NMOS
- V_{DS} 20V
- I_D (at V_{GS} = 10V) 1.3A
- $R_{DS(ON)}$ (at V_{GS} = 4.5V) < 210mΩ
- $R_{DS(ON)}$ (at V_{GS} = 2.5V) < 270mΩ
- 100% Avalanche Tested
- RoHS Compliant
- ESD (HBM) : 2.0KV

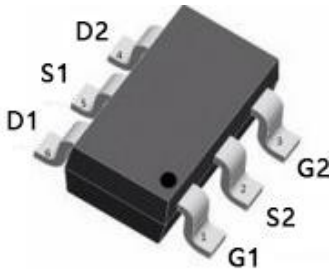
- PMOS
- V_{DS} -20V
- I_D (at V_{GS} = -10V) -1.1A
- $R_{DS(ON)}$ (at V_{GS} = -4.5V) < 460mΩ
- $R_{DS(ON)}$ (at V_{GS} = -2.5V) < 580mΩ
- 100% Avalanche Tested
- RoHS Compliant
- ESD (HBM) : 2.0KV

Application

- Power switch
- DC/DC converters



Schematic diagram



SOT-23-6L Dual

Ordering Information

Device	Package	Marking	Packaging
G1NP02LLE	SOT-23-6L Dual	G1NP02E	3000pcs/Reel

Absolute Maximum Ratings T_C = 25ºC, unless otherwise noted

Parameter	Symbol	NMOS	PMOS	Unit
Drain-Source Voltage	V_{DS}	20	-20	V
Continuous Drain Current	I_D	1.3	1.1	A
Pulsed Drain Current (note1)	I_{DM}	5.2	4.4	A
Gate-Source Voltage	V_{GS}	±10	±10	V
Power Dissipation	P_D	1.25	1.25	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	-55 To 150	ºC

Thermal Resistance

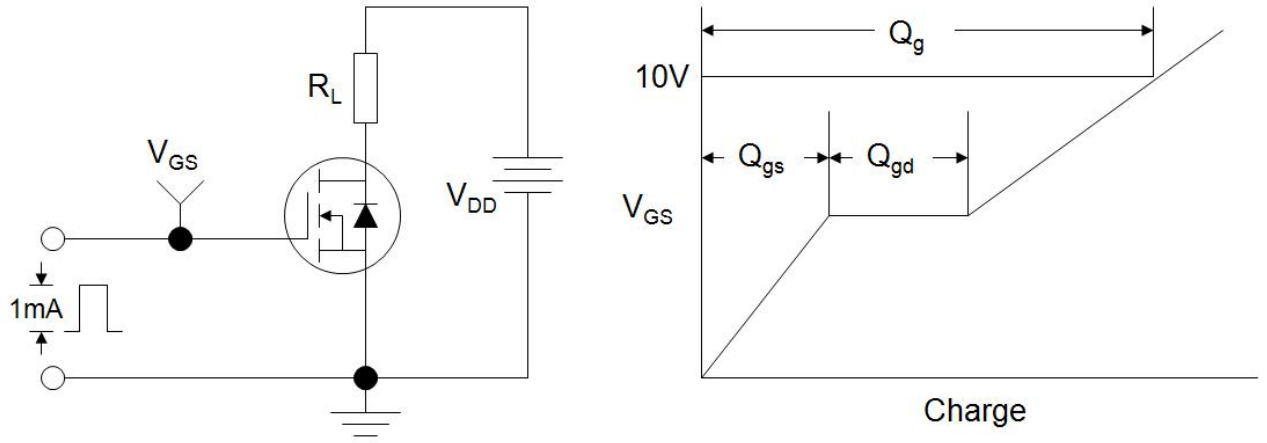
Parameter	Symbol	NMOS	PMOS	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	100	100	ºC/W

NMOS Specifications T_J = 25ºC, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Value**			**Unit**
			Min.	**Typ.**	**Max.**	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	20	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 20V, V_{GS} = 0V	--	--	1	μA
Gate-Source Leakage	I_{GSS}	V_{GS} = ±10V	--	--	±10	uA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	0.35	0.55	1	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = 4.5V, I_D = 0.65A	--	170	210	mΩ
		V_{GS} = 2.5V, I_D = 0.55A	--	220	270	
Forward Transconductance	g_{FS}	V_{GS} = 5V, I_D = 0.55A	--	1.3	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 10V, f = 1.0MHz	--	146	--	pF
Output Capacitance	C_{oss}		--	108	--	
Reverse Transfer Capacitance	C_{rss}		--	52	--	
Total Gate Charge	Q_g	V_{DD} = 10V, I_D = 0.65A, V_{GS} = 4.5V	--	1	--	nC
Gate-Source Charge	Q_{gs}		--	0.27	--	
Gate-Drain Charge	Q_{gd}		--	0.21	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 10V, I_D = 0.65A, R_G = 10Ω	--	17.5	--	ns
Turn-on Rise Time	t_r		--	2.1	--	
Turn-off Delay Time	$t_{d(off)}$		--	9.5	--	
Turn-off Fall Time	t_f		--	22	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	T_C = 25ºC	--	--	1.3	A
Body Diode Voltage	V_{SD}	T_J = 25ºC, I_{SD} =0.65A, V_{GS} = 0V	--	--	1.2	V
Reverse Recovery Charge	Qrr	I_F = 0.65A, V_{GS} = 0V di/dt=20A/us	--	0.39	--	nC
Reverse Recovery Time	Trr		--	14	--	ns

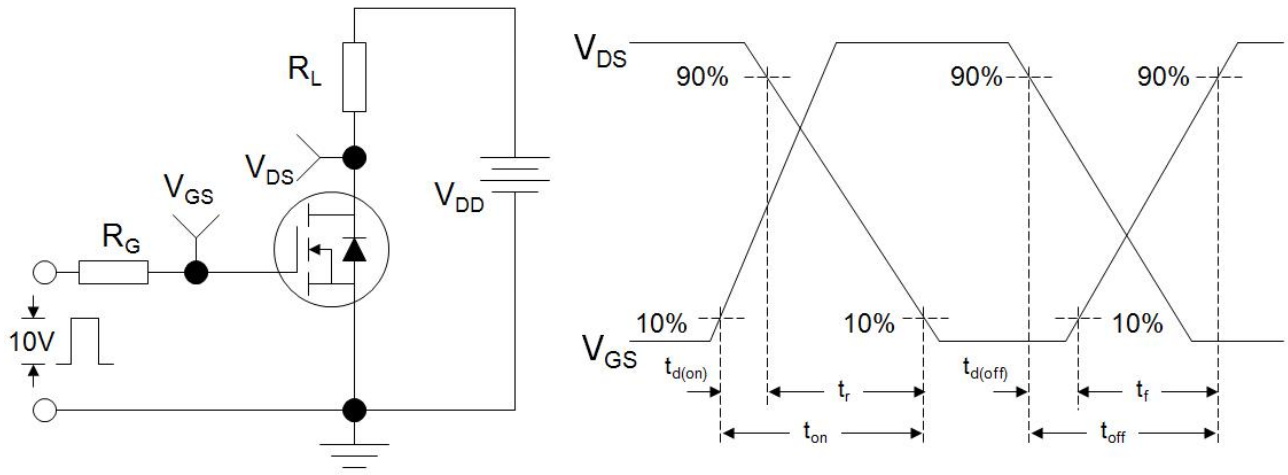
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

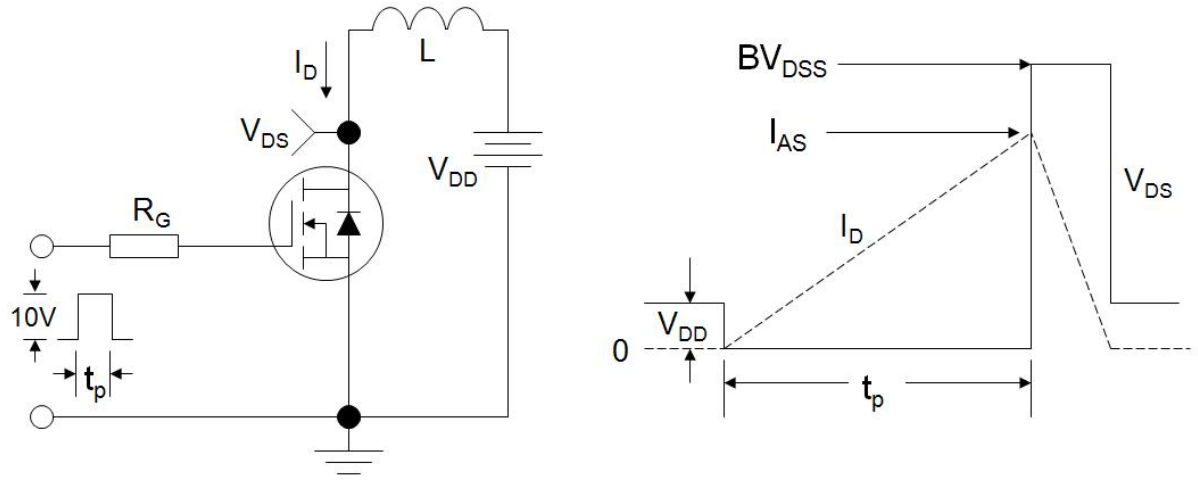
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



NMOS Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics

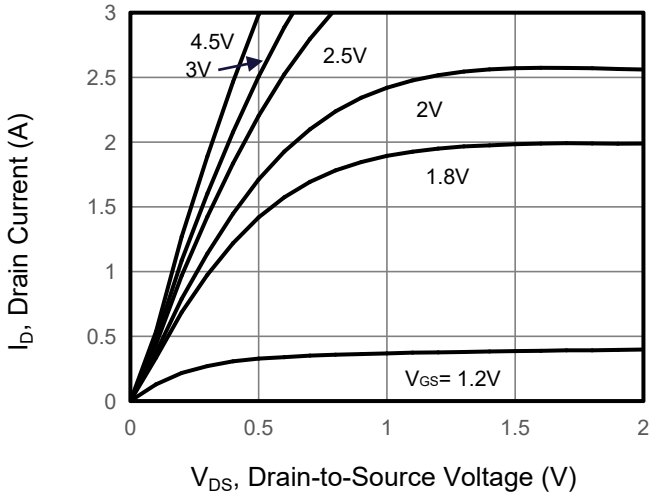


Figure 2. Transfer Characteristics

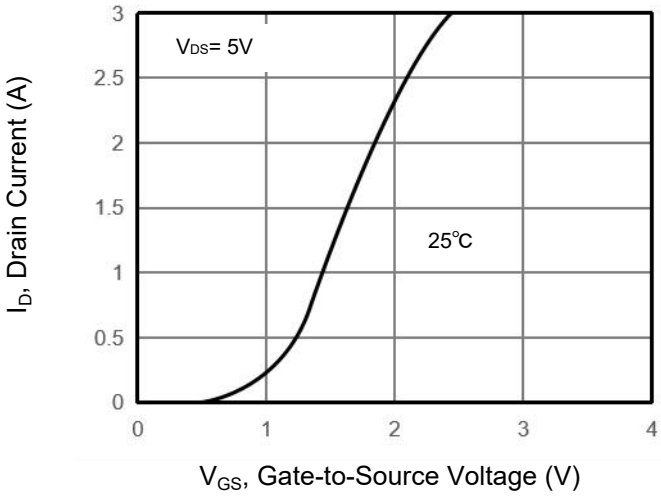


Figure 3. Drain Source On Resistance

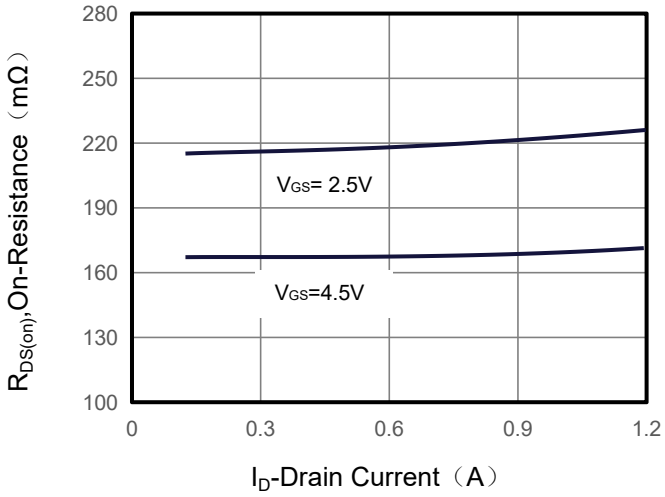


Figure 4. Gate Charge

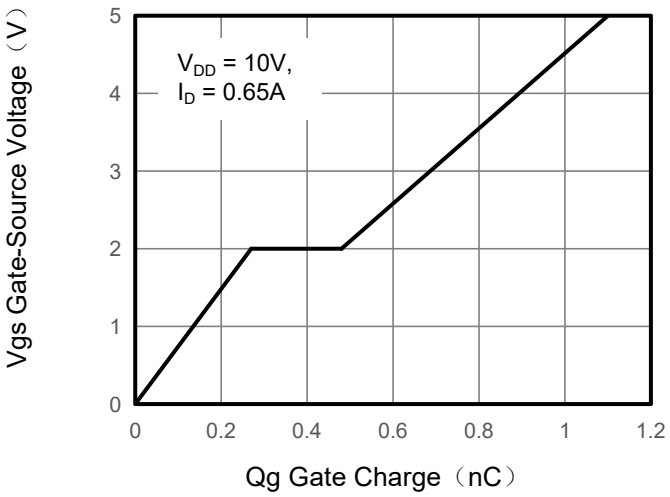


Figure 5. Capacitance

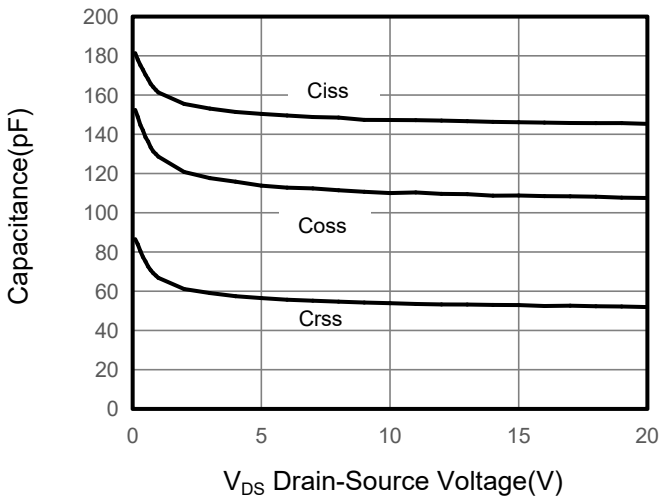
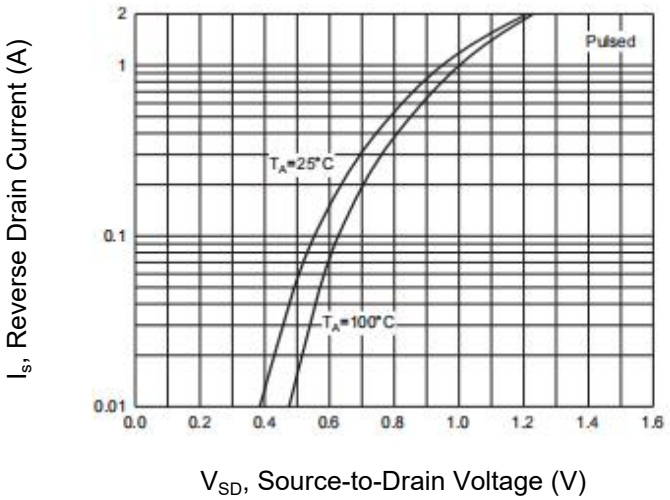


Figure 6. Source-Drain Diode Forward



NMOS Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. Drain-Source On-Resistance

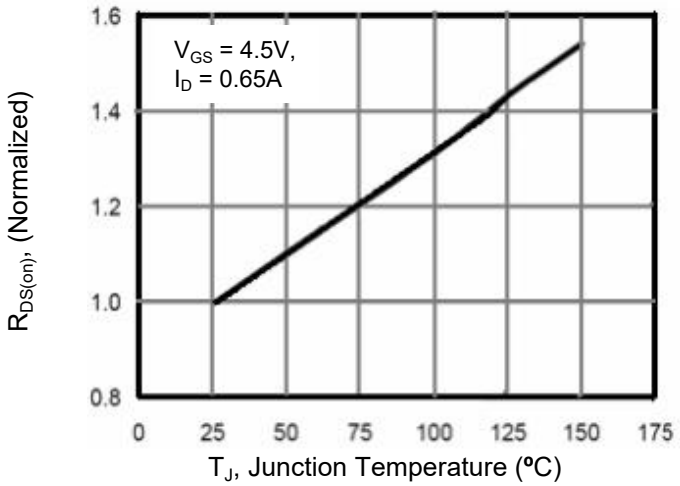


Figure 8. Safe Operation Area

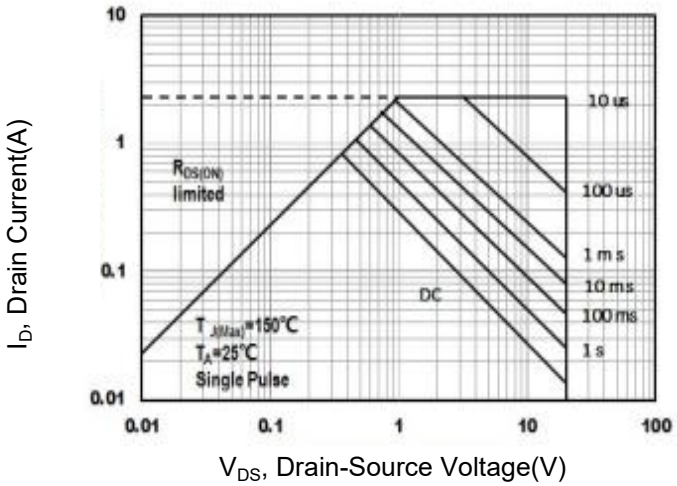
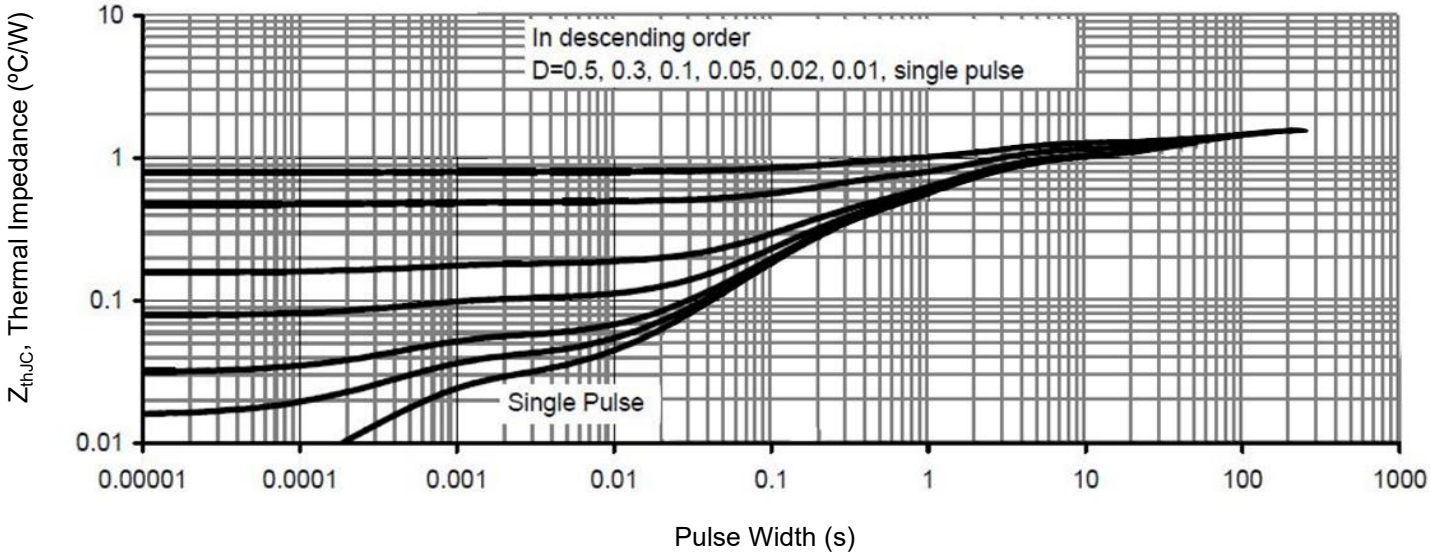


Figure 9. Normalized Maximum Transient Thermal Impedance

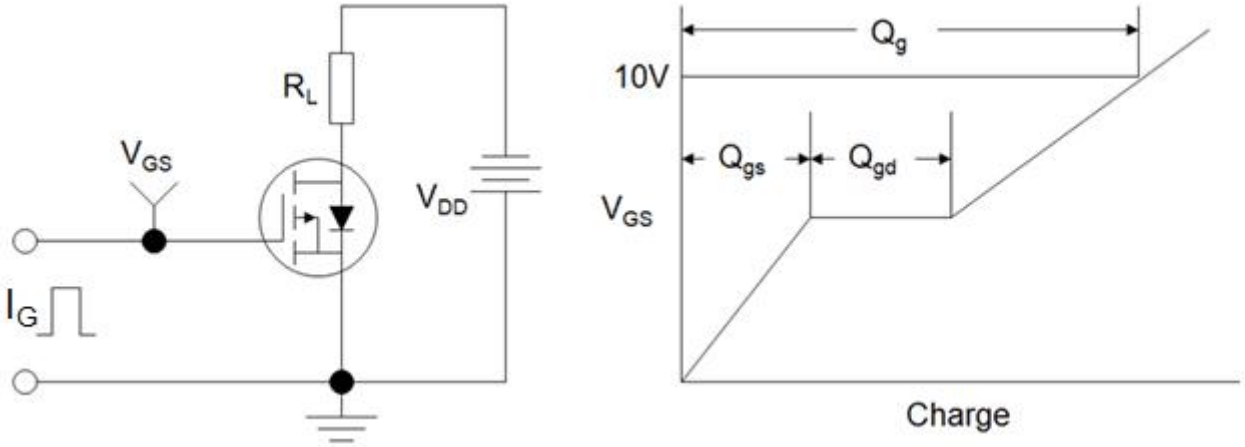


PMOS Specifications T_J = 25ºC, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Value**			**Unit**
			Min.	**Typ.**	**Max.**	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = -250μA	-20	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -20V, V_{GS} = 0V	--	--	-1	μA
Gate-Source Leakage	I_{GSS}	V_{GS} = ±10V	--	--	±10	uA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250μA	-0.35	-0.55	-0.8	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = -4.5V, I_D = -0.5A	--	380	460	mΩ
		V_{GS} = -2.5V, I_D = -0.5A	--	480	580	
Forward Transconductance	g_{FS}	V_{DS} = -5V,I_D = -0.5A	--	1.3	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = -10V, f = 1.0MHz	--	177	--	pF
Output Capacitance	C_{oss}		--	109	--	
Reverse Transfer Capacitance	C_{rss}		--	51	--	
Total Gate Charge	Q_g	V_{DD} = -10V, I_D = -0.5A, V_{GS} = -4.5V	--	1.22	--	nC
Gate-Source Charge	Q_{gs}		--	0.36	--	
Gate-Drain Charge	Q_{gd}		--	0.26	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = -10V, I_D = -0.5A, R_G = 3Ω	--	18	--	ns
Turn-on Rise Time	t_r		--	4.5	--	
Turn-off Delay Time	$t_{d(off)}$		--	23	--	
Turn-off Fall Time	t_f		--	15	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	T_C = 25ºC	--	--	-1.1	A
Body Diode Voltage	V_{SD}	T_J = 25ºC, I_{SD} = -0.5A, V_{GS} = 0V	--	--	-1.2	V
Reverse Recovery Charge	Q_{rr}	I_F = -0.5A, V_{GS} = 0V di/dt=-20A/us	--	0.95	--	nC
Reverse Recovery Time	T_{rr}		--	24	--	ns

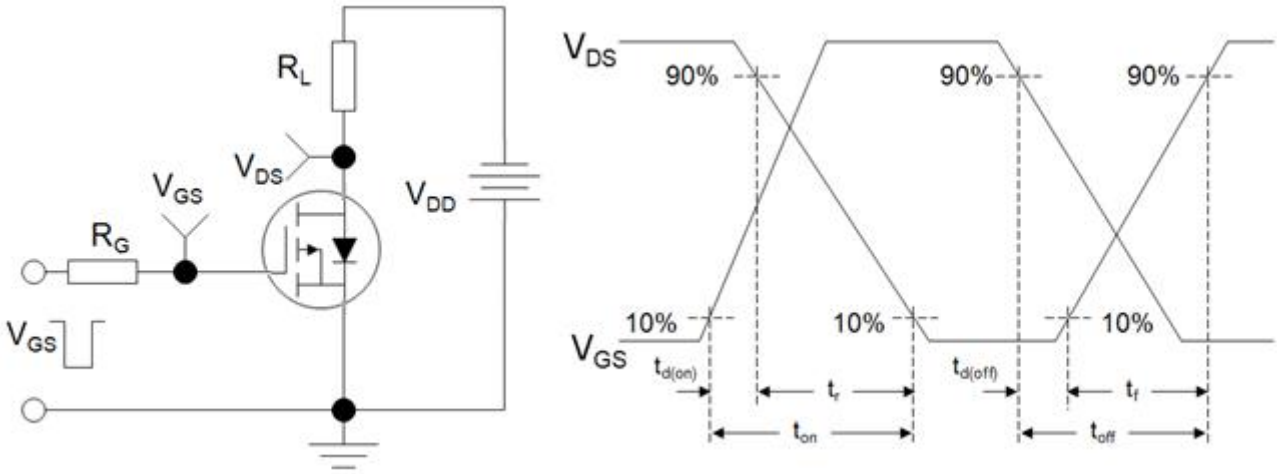
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

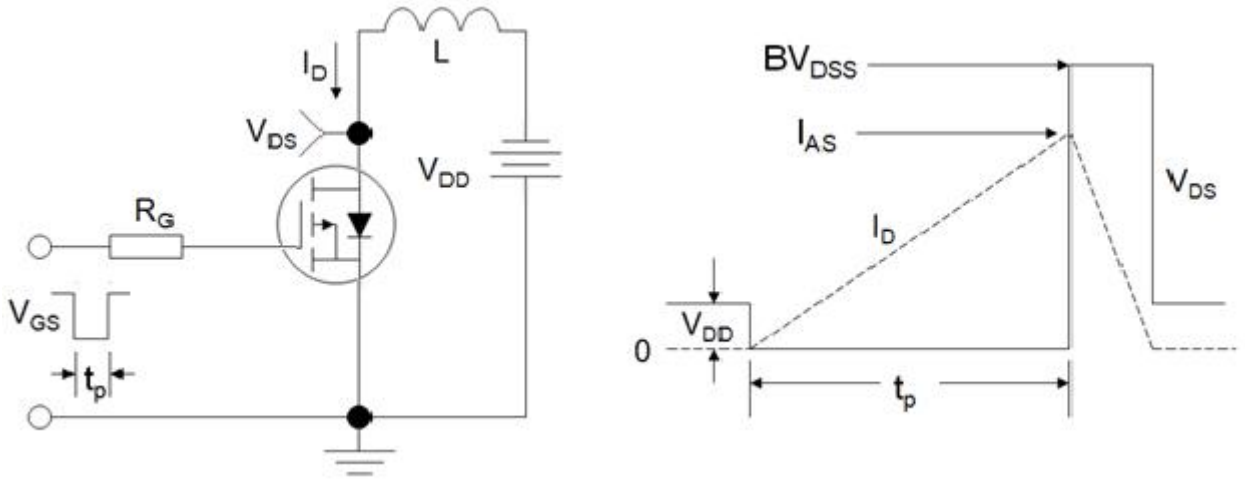
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



PMOS Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics

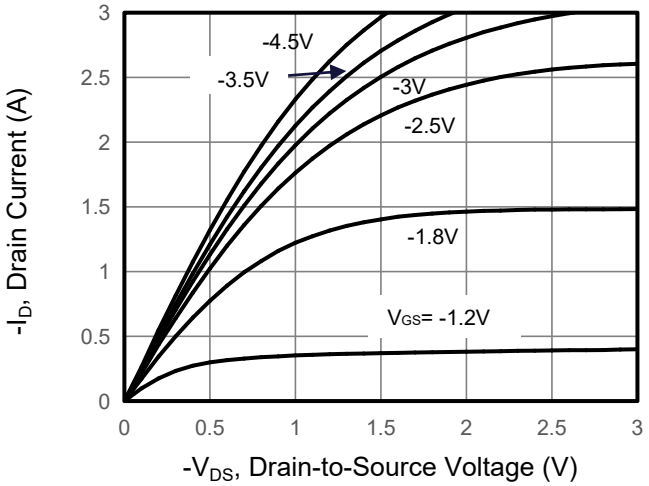


Figure 2. Transfer Characteristics

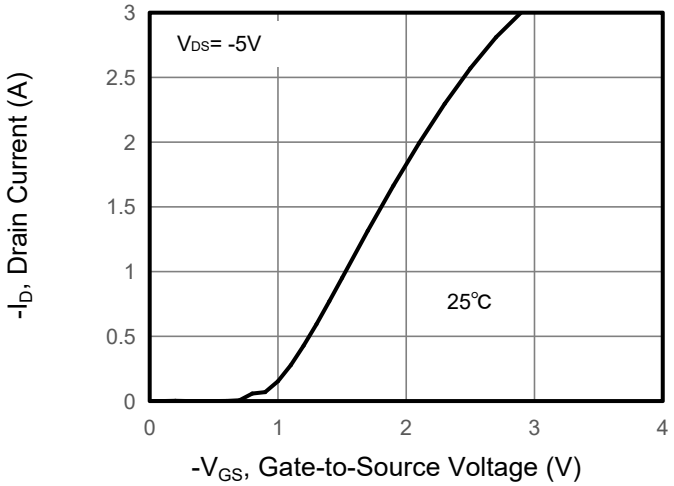


Figure 3.Drain Source On Resistance

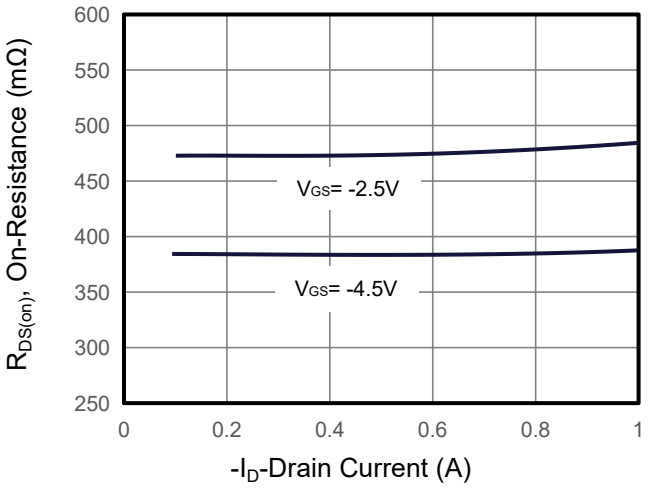


Figure 4. Gate Charge

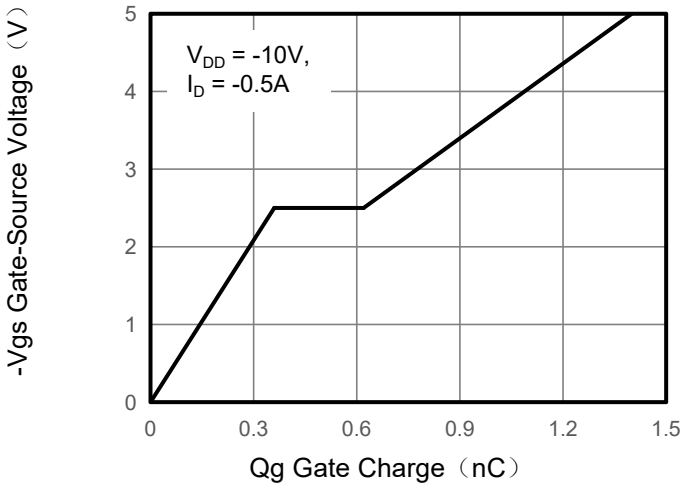


Figure 5. Capacitance

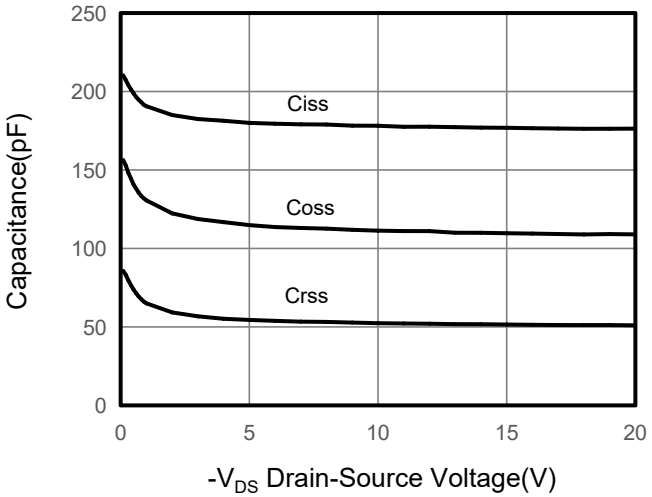
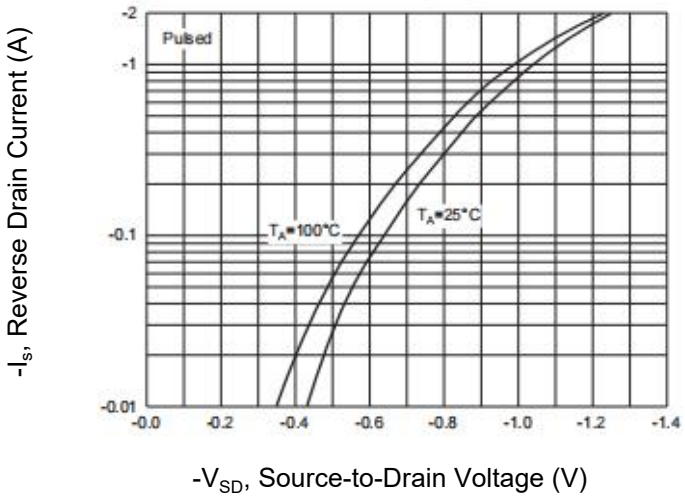


Figure 6. Source-Drain Diode Forward



PMOS Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. Drain-Source On-Resistance

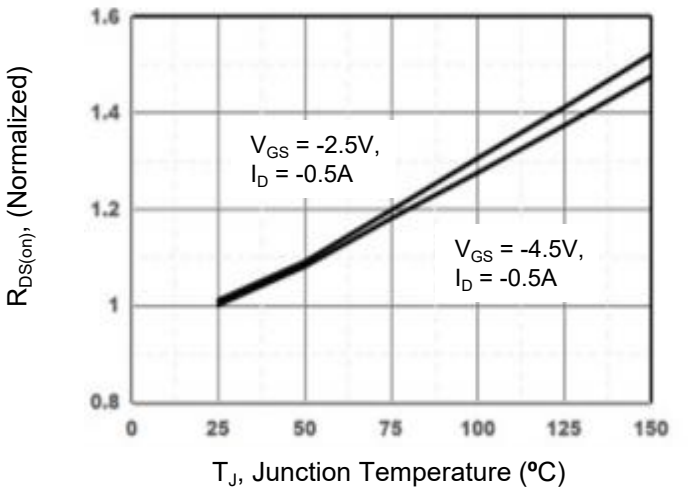


Figure 10. Safe Operation Area

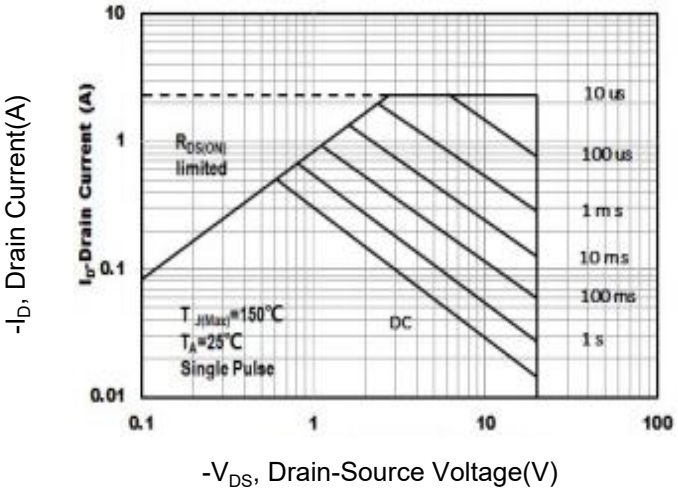
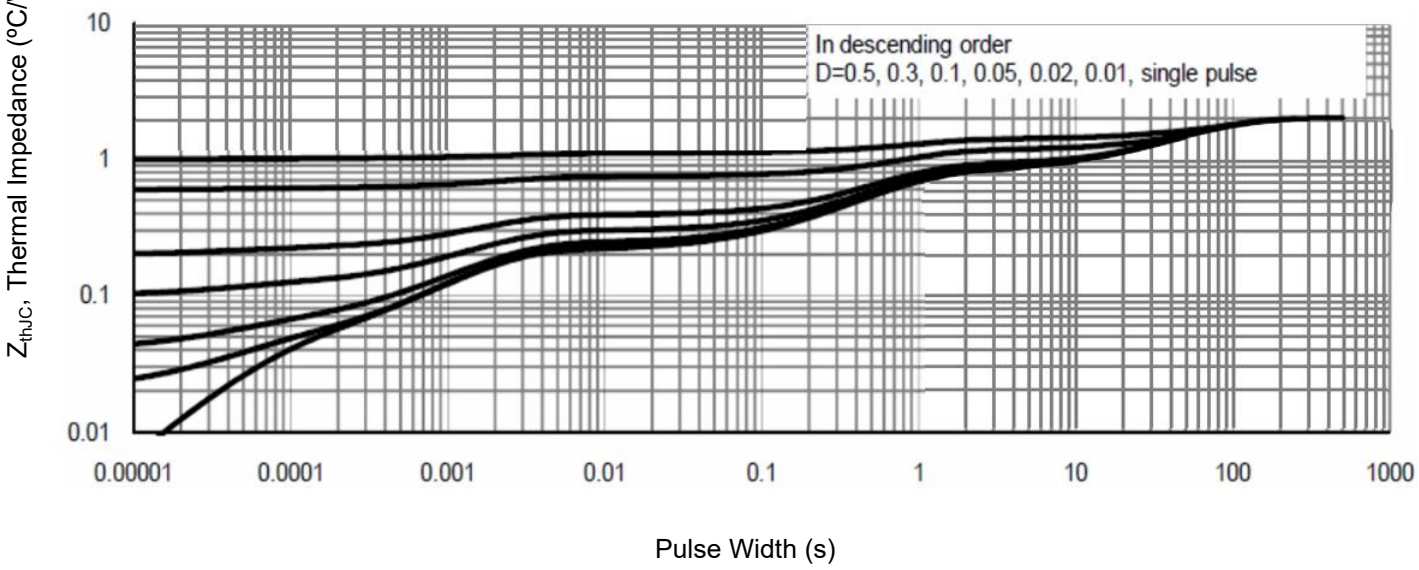
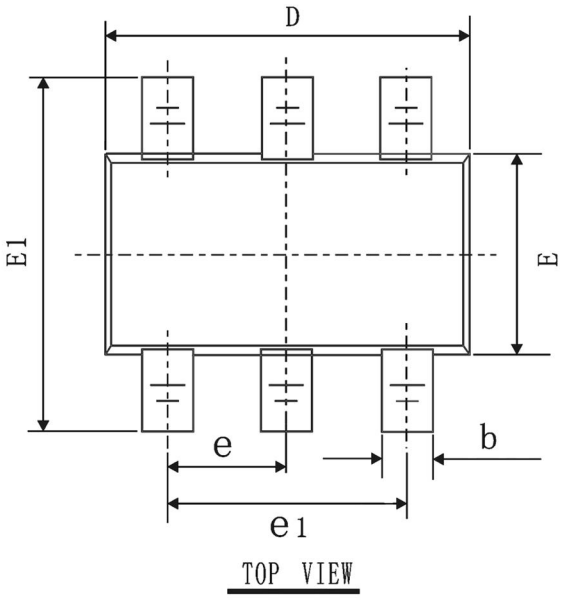


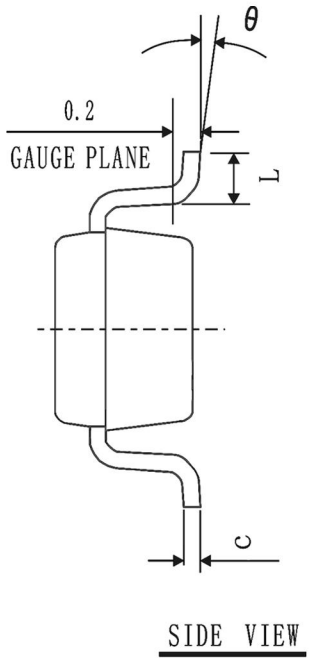
Figure 9. Normalized Maximum Transient Thermal Impedance



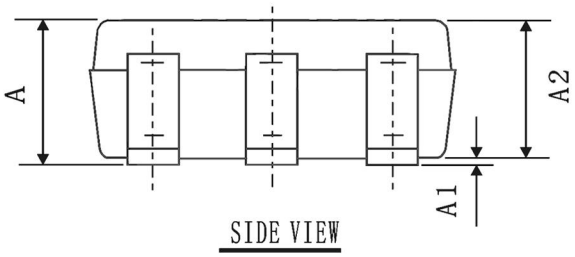
SOT-23-6L Dual Package Information



TOP VIEW



SIDE VIEW



SIDE VIEW

COMMON DIMENSIONS
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	——	——	1.20
A1	0.00	0.05	0.10
A2	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.10	0.125	0.15
e1	1.80	1.90	2.00
D	2.80	2.90	3.00
E	1.50	1.60	1.70
E1	2.60	2.80	3.00
L	0.30	0.45	0.60
θ	0°	4°	8°
e	0.95BSC		